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To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

Chung-Jung Lee
Tong-Chern Ong

10-25-04

2. Name and address of receiving party(ies)

Name: Taiwan Semiconductor Manufacturing

Internal Address: Co., Ltd.

Additional name(s) of conveying party(ies) attached? Yes No

3. Nature of conveyance:

- Assignment Merger
- Security Agreement Change of Name
- Other _____

Street Address: No. 8, Li-Hsin Road 6

Science Based Industrial Park, Hsin-Chu

City: Taiwan State: Zip: ROC 300-77

Execution Date: Oct. 8 and 12, 2004

Additional name(s) & address(es) attached? Yes No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: 10/25/04

A. Patent Application No.(s) _____

B. Patent No.(s) _____

Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Howard Chen

Internal Address: _____

Duane Morris LLP

Street Address: One Market Street

Spear Tower, Suite 2000

City: San Francisco State: CA Zip: 94105-1104

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41).....\$ 40.00

- Enclosed
- Authorized to be charged to deposit account

8. Deposit account number:

04-1679

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9. Signature.

Howard Chen, Reg. #46,615

Name of Person Signing

Howard Chen
Signature

10/25/04
Date

Total number of pages including cover sheet, attachments, and documents: 3

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Documents to be recorded with required cover sheet information to:
Commissioner of Patents & Trademarks, Box Assignments
Washington, D.C. 20231

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ASSIGNMENT AND AGREEMENT

For value received, I/we, **Chung-Jung Lee and Tong-Chern Ong** hereby sell, assign and transfer to **Taiwan Semiconductor Manufacturing Co., Ltd.**, with its principal place of business located at No. 8, Li-Hsin Road 6, Science-Based Industrial Park, Hsin-Chu, Taiwan 300-77, Republic of China, and its successors, assigns and legal representatives, the entire right, title and interest, for the United States of America, in and to certain inventions related to **IMPROVED SEMICONDUCTOR DEVICES WITH REDUCED IMPACT FROM ALIEN PARTICLES** described in an application for Letters Patent of the United States and all the rights and privileges in said application and under any and all Letters Patent and any divisions, continuations, continuations-in-part, reexamination certificates, reissues, and extensions thereof that may be granted in the United States for said inventions; and I/we also concurrently hereby sell, assign and transfer to Taiwan Semiconductor Manufacturing Co., Ltd. the entire right, title and interest in and to said inventions for all countries foreign to the United States, including all rights of priority arising from the application aforesaid, and all the rights and privileges under any and all forms of protection, including Letters Patent, that may be granted in said countries foreign to the United States for said inventions.

I/we authorize Taiwan Semiconductor Manufacturing Co., Ltd. to make application for such protection in its own name and maintain such protection in any and all countries foreign to the United States, and to invoke and claim for any application for patent or other form of protection for said inventions, without further authorization from me/us, any and all benefits, including the right of priority provided by any and all treaties, conventions, or agreements.

I/we hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any document which may be required in any country in proof of the right of Taiwan Semiconductor Manufacturing Co., Ltd. to apply for patent or other form of protection for said inventions and to claim the aforesaid benefit of the right of priority.

I/we request that any and all patents for said inventions be issued to Taiwan Semiconductor Manufacturing Co., Ltd. in the United States and in all countries foreign to the United States, or to such nominees as Taiwan Semiconductor Manufacturing Co., Ltd. may designate.

I/we agree that, when requested, I/we shall, without charge to Taiwan Semiconductor Manufacturing Co., Ltd. but at its expense, sign all papers, and do all acts which may be necessary, desirable or convenient in connection with said applications, patents, or other forms of protection.

Assignment and Agreement 1

Inventor No. 1:

Dated: 10/8/2004 Chung-Jung Lee
Chung-Jung Lee

Residence: 10th - 1, No. 373, Sec I, Guangfu Rd.,
Hsinchu City 300, Taiwan (R.O.C.)

Citizenship: Taiwan, R.O.C.

Inventor No. 2:

Dated: 10/12/04 Tong-Chern Ong
Tong-Chern Ong

Residence: 3rd floor, #2, 86th Lane, Min-Shun St., Chong-Her City,
Taipei, Taiwan, R.O.C.

Citizenship: Taiwan, R.O.C.

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